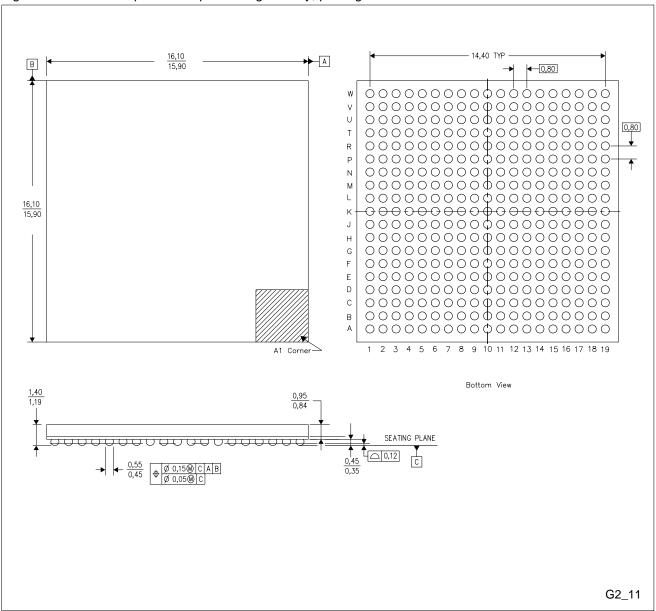
TFBGA-361 ASC55A9009

Thin Profile Fine Pitch Ball Grid Array

Package Outlines

Figure 1. 361-ball thin profile fine pitch ball grid array, package outline



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. This is a Pb-free solder ball design.
- D. Falls within JEDEC MO-275.